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Understanding [Embedded - Microprocessors](#)

Embedded microprocessors are specialized computing chips designed to perform specific tasks within an embedded system. Unlike general-purpose microprocessors found in personal computers, embedded microprocessors are tailored for dedicated functions within larger systems, offering optimized performance, efficiency, and reliability. These microprocessors are integral to the operation of countless electronic devices, providing the computational power necessary for controlling processes, handling data, and managing communications.

Applications of [Embedded - Microprocessors](#)

Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

Details

| | |
|---------------------------------|---|
| Product Status | Obsolete |
| Core Processor | MPC8xx |
| Number of Cores/Bus Width | 1 Core, 32-Bit |
| Speed | 50MHz |
| Co-Processors/DSP | Communications; CPM |
| RAM Controllers | DRAM |
| Graphics Acceleration | No |
| Display & Interface Controllers | - |
| Ethernet | 10Mbps (1) |
| SATA | - |
| USB | USB 1.x (1) |
| Voltage - I/O | 3.3V |
| Operating Temperature | -40°C ~ 95°C (TA) |
| Security Features | - |
| Package / Case | 256-BGA |
| Supplier Device Package | 256-PBGA (23x23) |
| Purchase URL | https://www.e-xfl.com/product-detail/nxp-semiconductors/xpc850srczt50bu |

- Gate mode can enable/disable counting
- Interrupt can be masked on reference match and event capture
- Interrupts
 - Eight external interrupt request (IRQ) lines
 - Twelve port pins with interrupt capability
 - Fifteen internal interrupt sources
 - Programmable priority among SCCs and USB
 - Programmable highest-priority request
- Single socket PCMCIA-ATA interface
 - Master (socket) interface, release 2.1 compliant
 - Single PCMCIA socket
 - Supports eight memory or I/O windows
- Communications processor module (CPM)
 - 32-bit, Harvard architecture, scalar RISC communications processor (CP)
 - Protocol-specific command sets (for example, GRACEFUL STOP TRANSMIT stops transmission after the current frame is finished or immediately if no frame is being sent and CLOSE RXBD closes the receive buffer descriptor)
 - Supports continuous mode transmission and reception on all serial channels
 - Up to 8 Kbytes of dual-port RAM
 - Twenty serial DMA (SDMA) channels for the serial controllers, including eight for the four USB endpoints
 - Three parallel I/O registers with open-drain capability
- Four independent baud-rate generators (BRGs)
 - Can be connected to any SCC, SMC, or USB
 - Allow changes during operation
 - Autobaud support option
- Two SCCs (serial communications controllers)
 - Ethernet/IEEE 802.3, supporting full 10-Mbps operation
 - HDLC/SDLC™ (all channels supported at 2 Mbps)
 - HDLC bus (implements an HDLC-based local area network (LAN))
 - Asynchronous HDLC to support PPP (point-to-point protocol)
 - AppleTalk®
 - Universal asynchronous receiver transmitter (UART)
 - Synchronous UART
 - Serial infrared (IrDA)
 - Totally transparent (bit streams)
 - Totally transparent (frame based with optional cyclic redundancy check (CRC))

Features

- QUICC multichannel controller (QMC) microcode features
 - Up to 64 independent communication channels on a single SCC
 - Arbitrary mapping of 0–31 channels to any of 0–31 TDM time slots
 - Supports either transparent or HDLC protocols for each channel
 - Independent TxBDs/Rx and event/interrupt reporting for each channel
- One universal serial bus controller (USB)
 - Supports host controller and slave modes at 1.5 Mbps and 12 Mbps
- Two serial management controllers (SMCs)
 - UART
 - Transparent
 - General circuit interface (GCI) controller
 - Can be connected to the time-division-multiplexed (TDM) channel
- One serial peripheral interface (SPI)
 - Supports master and slave modes
 - Supports multimaster operation on the same bus
- One I²C[®] (interprocessor-integrated circuit) port
 - Supports master and slave modes
 - Supports multimaster environment
- Time slot assigner
 - Allows SCCs and SMCs to run in multiplexed operation
 - Supports T1, CEPT, PCM highway, ISDN basic rate, ISDN primary rate, user-defined
 - 1- or 8-bit resolution
 - Allows independent transmit and receive routing, frame syncs, clocking
 - Allows dynamic changes
 - Can be internally connected to four serial channels (two SCCs and two SMCs)
- Low-power support
 - Full high: all units fully powered at high clock frequency
 - Full low: all units fully powered at low clock frequency
 - Doze: core functional units disabled except time base, decremter, PLL, memory controller, real-time clock, and CPM in low-power standby
 - Sleep: all units disabled except real-time clock and periodic interrupt timer. PLL is active for fast wake-up
 - Deep sleep: all units disabled including PLL, except the real-time clock and periodic interrupt timer
 - Low-power stop: to provide lower power dissipation

4 Thermal Characteristics

Table 3 shows the thermal characteristics for the MPC850.

Table 3. Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|---|---------------|-----------------|------|
| Thermal resistance for BGA ¹ | θ_{JA} | 40 ² | °C/W |
| | θ_{JA} | 31 ³ | °C/W |
| | θ_{JA} | 24 ⁴ | °C/W |
| Thermal Resistance for BGA (junction-to-case) | θ_{JC} | 8 | °C/W |

¹ For more information on the design of thermal vias on multilayer boards and BGA layout considerations in general, refer to AN-1231/D, Plastic Ball Grid Array Application Note available from your local Freescale sales office.

² Assumes natural convection and a single layer board (no thermal vias).

³ Assumes natural convection, a multilayer board with thermal vias⁴, 1 watt MPC850 dissipation, and a board temperature rise of 20°C above ambient.

⁴ Assumes natural convection, a multilayer board with thermal vias⁴, 1 watt MPC850 dissipation, and a board temperature rise of 13°C above ambient.

$$T_J = T_A + (P_D \bullet \theta_{JA})$$

$$P_D = (V_{DD} \bullet I_{DD}) + P_{I/O}$$

where:

$P_{I/O}$ is the power dissipation on pins

Table 4 provides power dissipation information.

Table 4. Power Dissipation (P_D)

| Characteristic | Frequency (MHz) | Typical ¹ | Maximum ² | Unit |
|--|-----------------|----------------------|----------------------|------|
| Power Dissipation All Revisions (1:1) Mode | 33 | TBD | 515 | mW |
| | 40 | TBD | 590 | mW |
| | 50 | TBD | 725 | mW |

¹ Typical power dissipation is measured at 3.3V

² Maximum power dissipation is measured at 3.65 V

Table 5 provides the DC electrical characteristics for the MPC850.

Table 5. DC Electrical Specifications

| Characteristic | Symbol | Min | Max | Unit |
|---|---------------------------|-------|-------|------|
| Operating voltage at 40 MHz or less | VDDH, VDDL, KAPWR, VDDSYN | 3.0 | 3.6 | V |
| Operating voltage at 40 MHz or higher | VDDH, VDDL, KAPWR, VDDSYN | 3.135 | 3.465 | V |
| Input high voltage (address bus, data bus, EXTAL, EXTCLK, and all bus control/status signals) | VIH | 2.0 | 3.6 | V |
| Input high voltage (all general purpose I/O and peripheral pins) | VIH | 2.0 | 5.5 | V |

Table 6. Bus Operation Timing ¹ (continued)

| Num | Characteristic | 50 MHz | | 66 MHz | | 80 MHz | | FFACT | Cap Load (default 50 pF) | Unit |
|------|---|--------|-------|--------|-------|--------|-------|-------|--------------------------------|------|
| | | Min | Max | Min | Max | Min | Max | | | |
| B22 | CLKOUT rising edge to \overline{CS} asserted GPCM ACS = 00 | 5.00 | 11.75 | 7.58 | 14.33 | 6.25 | 13.00 | 0.250 | 50.00 | ns |
| B22a | CLKOUT falling edge to \overline{CS} asserted GPCM ACS = 10, TRLX = 0,1 | — | 8.00 | — | 8.00 | — | 8.00 | — | 50.00 | ns |
| B22b | CLKOUT falling edge to \overline{CS} asserted GPCM ACS = 11, TRLX = 0, EBDF = 0 | 5.00 | 11.75 | 7.58 | 14.33 | 6.25 | 13.00 | 0.250 | 50.00 | ns |
| B22c | CLKOUT falling edge to \overline{CS} asserted GPCM ACS = 11, TRLX = 0, EBDF = 1 | 7.00 | 14.00 | 11.00 | 18.00 | 9.00 | 16.00 | 0.375 | 50.00 | ns |
| B23 | CLKOUT rising edge to \overline{CS} negated GPCM read access, GPCM write access ACS = 00, TRLX = 0 & CSNT = 0 | 2.00 | 8.00 | 2.00 | 8.00 | 2.00 | 8.00 | — | 50.00 | ns |
| B24 | A[6–31] to \overline{CS} asserted GPCM ACS = 10, TRLX = 0. | 3.00 | — | 6.00 | — | 4.00 | — | 0.250 | 50.00 | ns |
| B24a | A[6–31] to \overline{CS} asserted GPCM ACS = 11, TRLX = 0 | 8.00 | — | 13.00 | — | 11.00 | — | 0.500 | 50.00 | ns |
| B25 | CLKOUT rising edge to \overline{OE} , WE[0–3] asserted | — | 9.00 | — | 9.00 | — | 9.00 | — | 50.00 | ns |
| B26 | CLKOUT rising edge to \overline{OE} negated | 2.00 | 9.00 | 2.00 | 9.00 | 2.00 | 9.00 | — | 50.00 | ns |
| B27 | A[6–31] to \overline{CS} asserted GPCM ACS = 10, TRLX = 1 | 23.00 | — | 36.00 | — | 29.00 | — | 1.250 | 50.00 | ns |
| B27a | A[6–31] to \overline{CS} asserted GPCM ACS = 11, TRLX = 1 | 28.00 | — | 43.00 | — | 36.00 | — | 1.500 | 50.00 | ns |
| B28 | CLKOUT rising edge to WE[0–3] negated GPCM write access CSNT = 0 | — | 9.00 | — | 9.00 | — | 9.00 | — | 50.00 | ns |
| B28a | CLKOUT falling edge to WE[0–3] negated GPCM write access TRLX = 0,1 CSNT = 1, EBDF = 0 | 5.00 | 12.00 | 8.00 | 14.00 | 6.00 | 13.00 | 0.250 | 50.00 | ns |
| B28b | CLKOUT falling edge to \overline{CS} negated GPCM write access TRLX = 0,1 CSNT = 1, ACS = 10 or ACS = 11, EBDF = 0 | — | 12.00 | — | 14.00 | — | 13.00 | 0.250 | 50.00 | ns |

Table 6. Bus Operation Timing ¹ (continued)

| Num | Characteristic | 50 MHz | | 66 MHz | | 80 MHz | | FFACT | Cap Load (default 50 pF) | Unit |
|------|--|--------|-------|--------|-------|--------|-------|-------|--------------------------------|------|
| | | Min | Max | Min | Max | Min | Max | | | |
| B31 | CLKOUT falling edge to \overline{CS} valid - as requested by control bit CST4 in the corresponding word in the UPM | 1.50 | 6.00 | 1.50 | 6.00 | 1.50 | 6.00 | — | 50.00 | ns |
| B31a | CLKOUT falling edge to \overline{CS} valid - as requested by control bit CST1 in the corresponding word in the UPM | 5.00 | 12.00 | 8.00 | 14.00 | 6.00 | 13.00 | 0.250 | 50.00 | ns |
| B31b | CLKOUT rising edge to \overline{CS} valid - as requested by control bit CST2 in the corresponding word in the UPM | 1.50 | 8.00 | 1.50 | 8.00 | 1.50 | 8.00 | — | 50.00 | ns |
| B31c | CLKOUT rising edge to \overline{CS} valid - as requested by control bit CST3 in the corresponding word in the UPM | 5.00 | 12.00 | 8.00 | 14.00 | 6.00 | 13.00 | 0.250 | 50.00 | ns |
| B31d | CLKOUT falling edge to \overline{CS} valid - as requested by control bit CST1 in the corresponding word in the UPM EBDF = 1 | 9.00 | 14.00 | 13.00 | 18.00 | 11.00 | 16.00 | 0.375 | 50.00 | ns |
| B32 | CLKOUT falling edge to \overline{BS} valid - as requested by control bit BST4 in the corresponding word in the UPM | 1.50 | 6.00 | 1.50 | 6.00 | 1.50 | 6.00 | — | 50.00 | ns |
| B32a | CLKOUT falling edge to \overline{BS} valid - as requested by control bit BST1 in the corresponding word in the UPM, EBDF = 0 | 5.00 | 12.00 | 8.00 | 14.00 | 6.00 | 13.00 | 0.250 | 50.00 | ns |
| B32b | CLKOUT rising edge to \overline{BS} valid - as requested by control bit BST2 in the corresponding word in the UPM | 1.50 | 8.00 | 1.50 | 8.00 | 1.50 | 8.00 | — | 50.00 | ns |
| B32c | CLKOUT rising edge to \overline{BS} valid - as requested by control bit BST3 in the corresponding word in the UPM | 5.00 | 12.00 | 8.00 | 14.00 | 6.00 | 13.00 | 0.250 | 50.00 | ns |
| B32d | CLKOUT falling edge to \overline{BS} valid - as requested by control bit BST1 in the corresponding word in the UPM, EBDF = 1 | 9.00 | 14.00 | 13.00 | 18.00 | 11.00 | 16.00 | 0.375 | 50.00 | ns |
| B33 | CLKOUT falling edge to GPL valid - as requested by control bit GxT4 in the corresponding word in the UPM | 1.50 | 6.00 | 1.50 | 6.00 | 1.50 | 6.00 | — | 50.00 | ns |

Figure 6 provides the timing for the synchronous input signals.

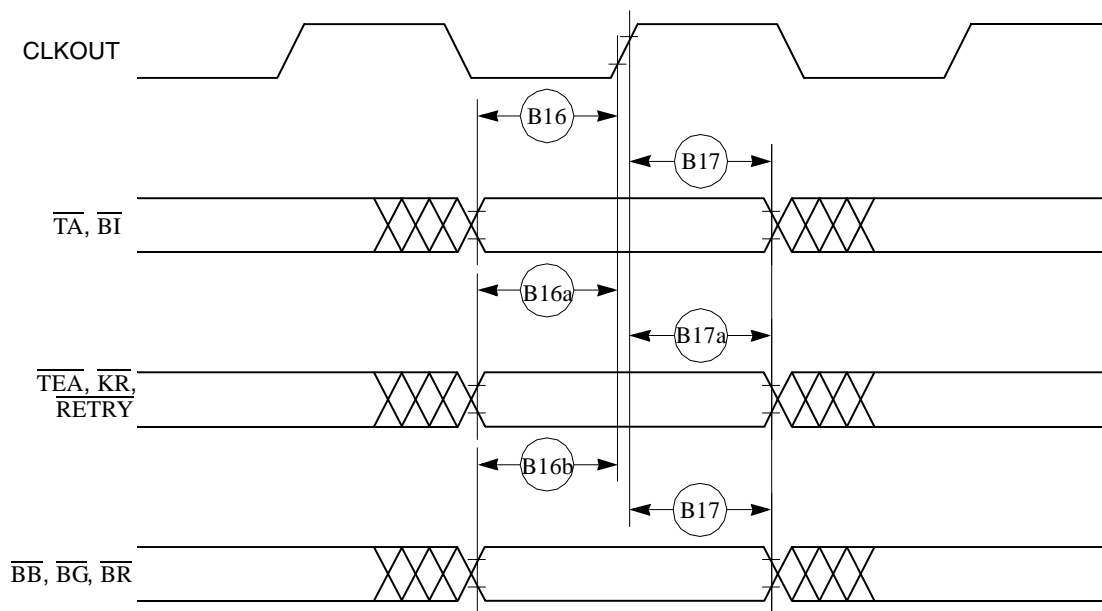


Figure 6. Synchronous Input Signals Timing

Figure 7 provides normal case timing for input data.

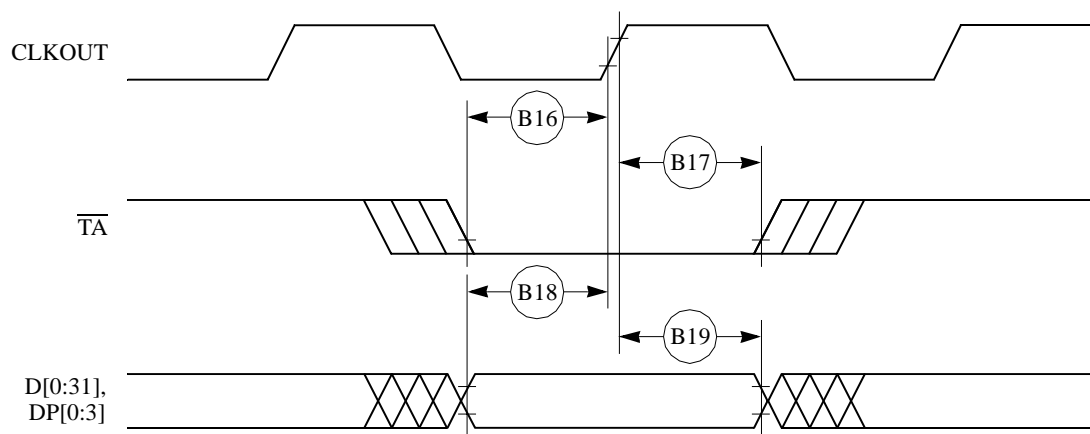


Figure 7. Input Data Timing in Normal Case

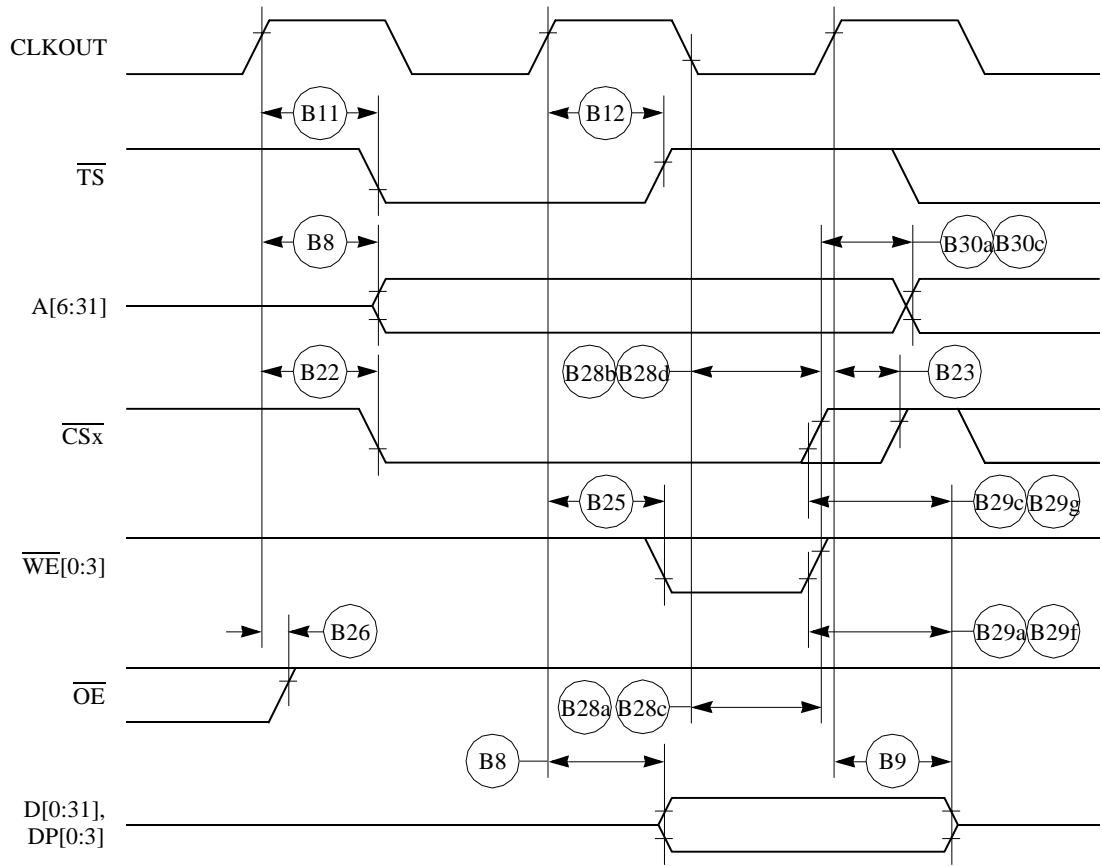


Figure 14. External Bus Write Timing (GPCM Controlled—TRLX = 0, CSNT = 1)

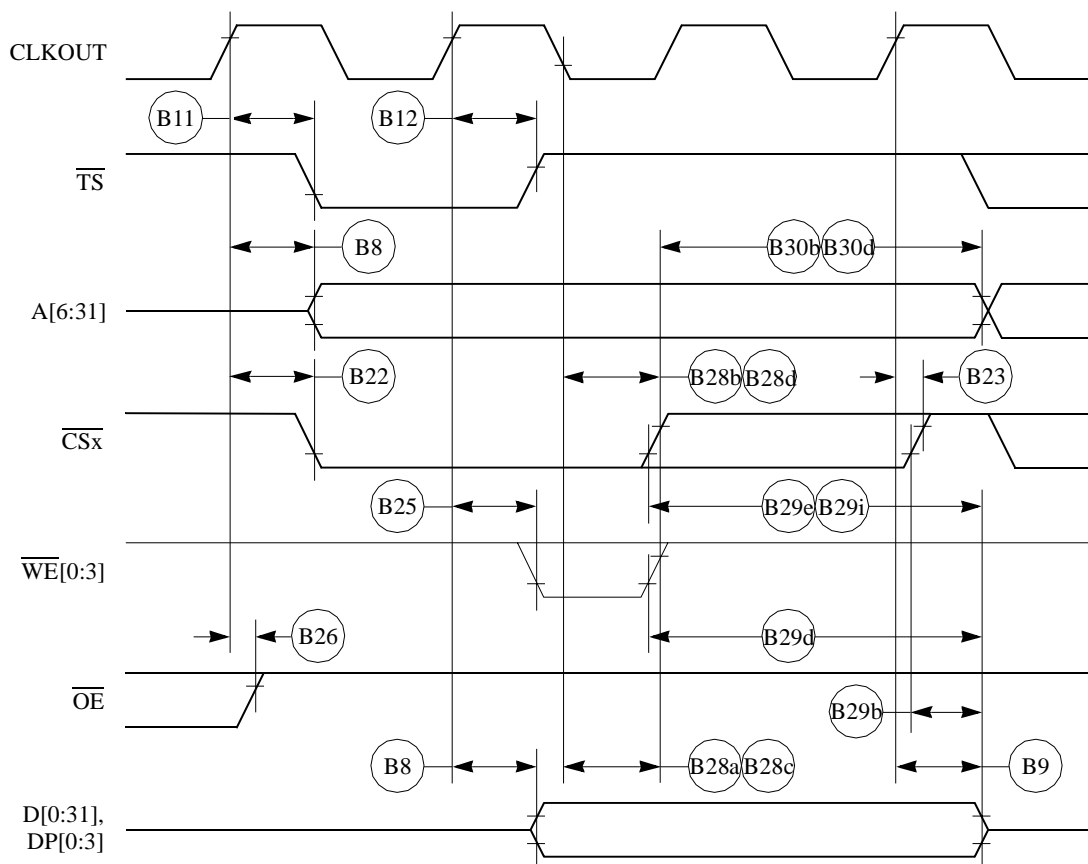


Figure 15. External Bus Write Timing (GPCM Controlled—TRLX = 1, CSNT = 1)

Figure 17 provides the timing for the asynchronous asserted UPWAIT signal controlled by the UPM.

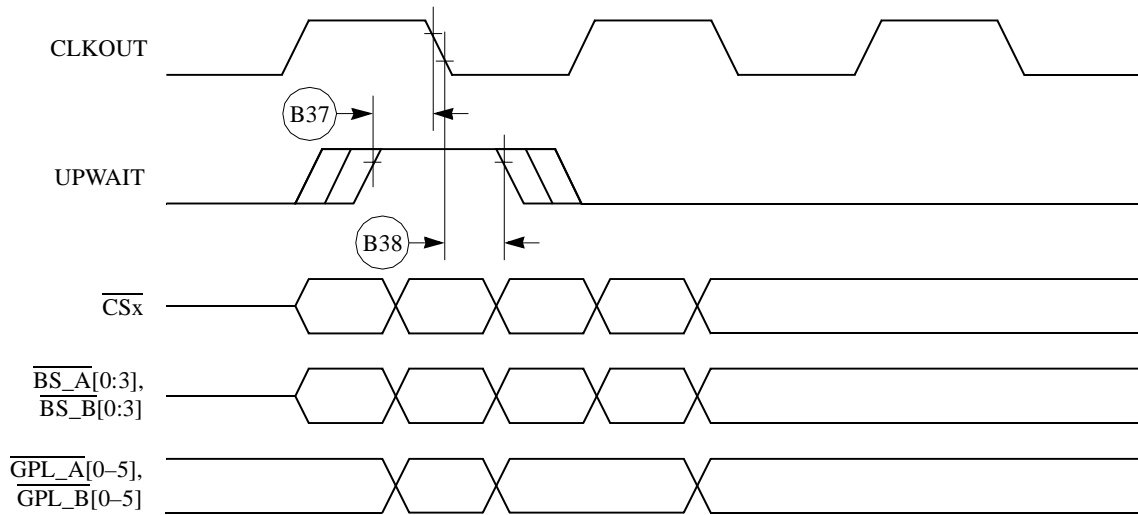


Figure 17. Asynchronous UPWAIT Asserted Detection in UPM Handled Cycles Timing

Figure 18 provides the timing for the asynchronous negated UPWAIT signal controlled by the UPM.

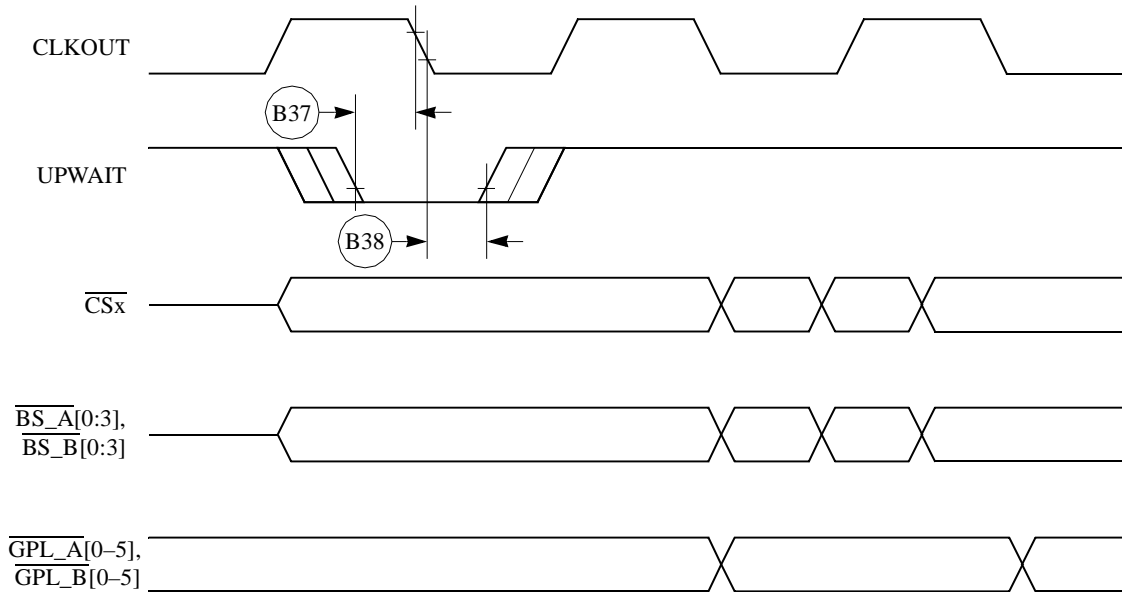


Figure 18. Asynchronous $\overline{\text{UPWAIT}}$ Negated Detection in UPM Handled Cycles Timing

Figure 19 provides the timing for the synchronous external master access controlled by the GPCM.

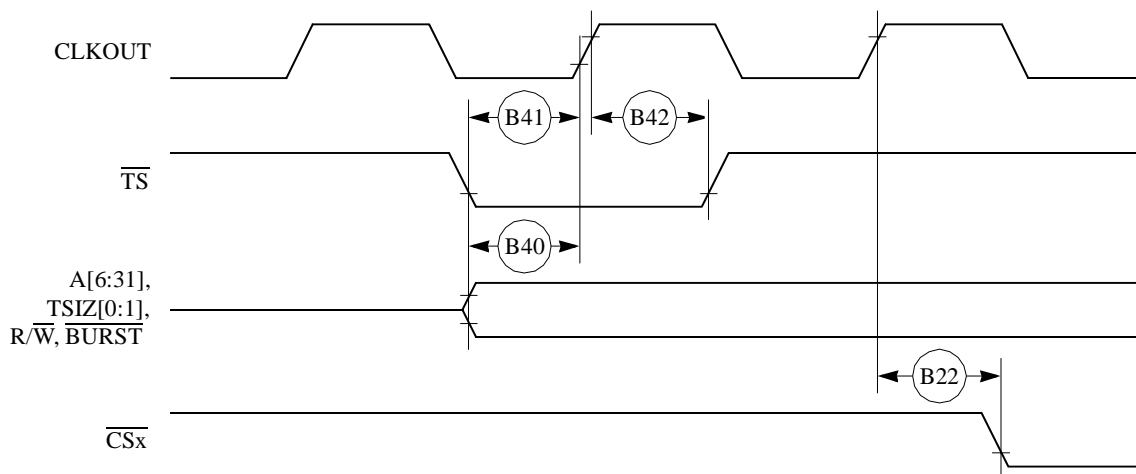


Figure 19. Synchronous External Master Access Timing (GPCM Handled ACS = 00)

Figure 20 provides the timing for the asynchronous external master memory access controlled by the GPCM.

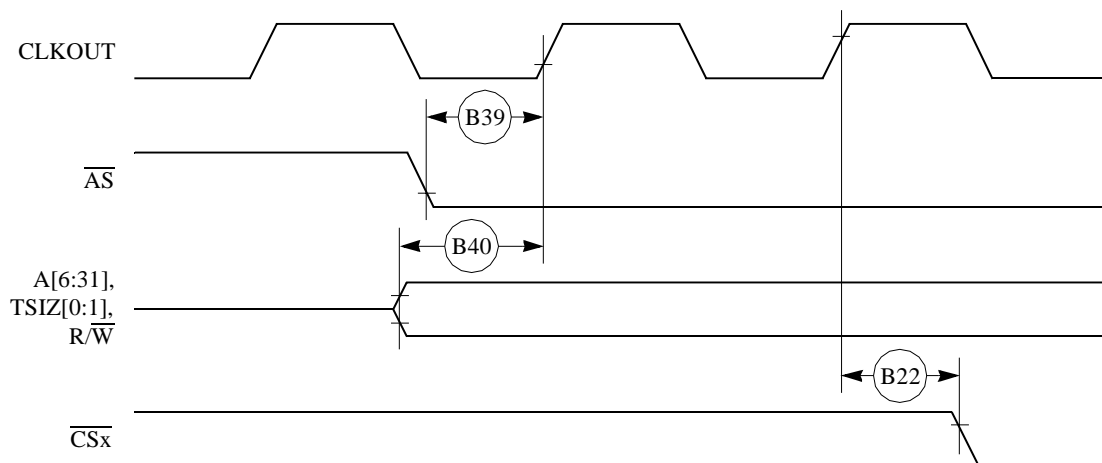


Figure 20. Asynchronous External Master Memory Access Timing (GPCM Controlled—ACS = 00)

Figure 21 provides the timing for the asynchronous external master control signals negation.

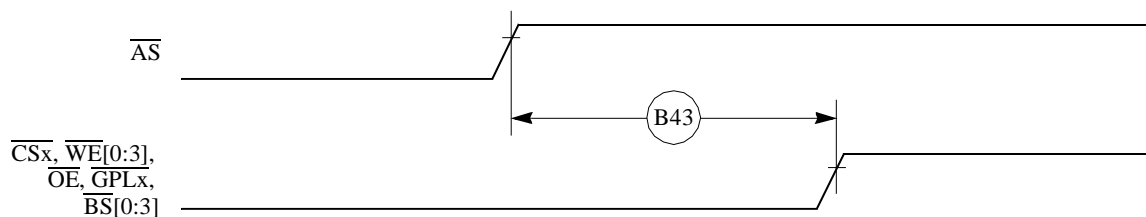


Figure 21. Asynchronous External Master—Control Signals Negation Timing

Table 7 provides interrupt timing for the MPC850.

Table 7. Interrupt Timing

| Num | Characteristic ¹ | 50 MHz | | 66MHz | | 80 MHz | | Unit |
|-----|--|--------|-----|-------|-----|--------|-----|------|
| | | Min | Max | Min | Max | Min | Max | |
| I39 | $\overline{\text{IRQx}}$ valid to CLKOUT rising edge (set up time) | 6.00 | — | 6.00 | — | 6.00 | — | ns |
| I40 | $\overline{\text{IRQx}}$ hold time after CLKOUT. | 2.00 | — | 2.00 | — | 2.00 | — | ns |
| I41 | $\overline{\text{IRQx}}$ pulse width low | 3.00 | — | 3.00 | — | 3.00 | — | ns |
| I42 | $\overline{\text{IRQx}}$ pulse width high | 3.00 | — | 3.00 | — | 3.00 | — | ns |
| I43 | $\overline{\text{IRQx}}$ edge-to-edge time | 80.00 | — | 121.0 | — | 100.0 | — | ns |

¹ The timings I39 and I40 describe the testing conditions under which the $\overline{\text{IRQ}}$ lines are tested when being defined as level sensitive. The $\overline{\text{IRQ}}$ lines are synchronized internally and do not have to be asserted or negated with reference to the CLKOUT.

The timings I41, I42, and I43 are specified to allow the correct function of the $\overline{\text{IRQ}}$ lines detection circuitry, and has no direct relation with the total system interrupt latency that the MPC850 is able to support

Figure 22 provides the interrupt detection timing for the external level-sensitive lines.

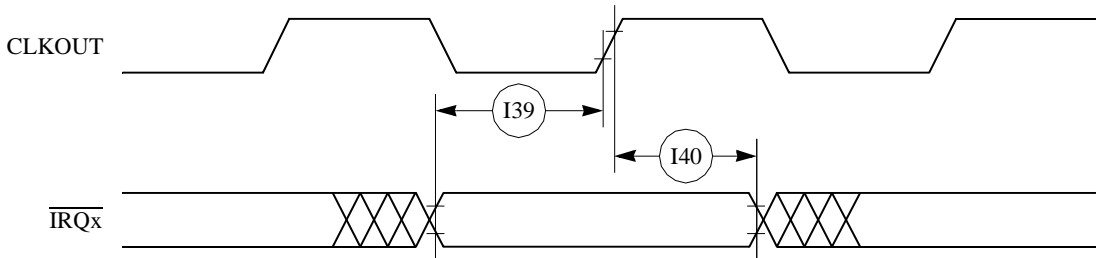


Figure 22. Interrupt Detection Timing for External Level Sensitive Lines

Figure 23 provides the interrupt detection timing for the external edge-sensitive lines.

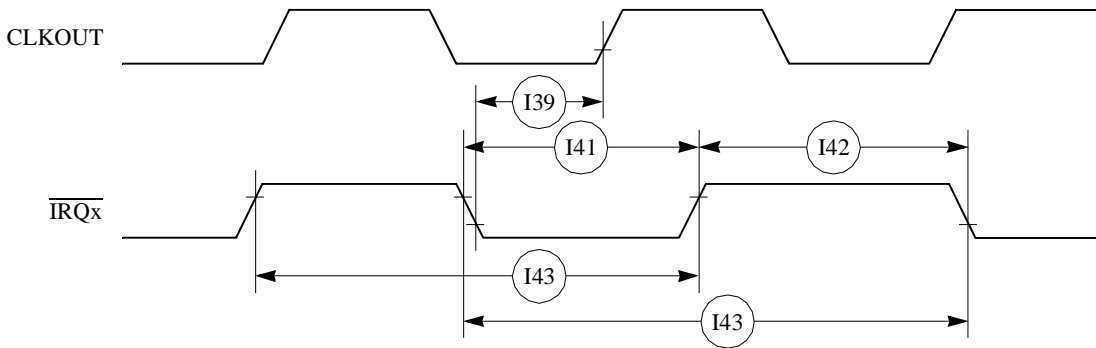


Figure 23. Interrupt Detection Timing for External Edge Sensitive Lines

Figure 31 shows the reset timing for the data bus configuration.

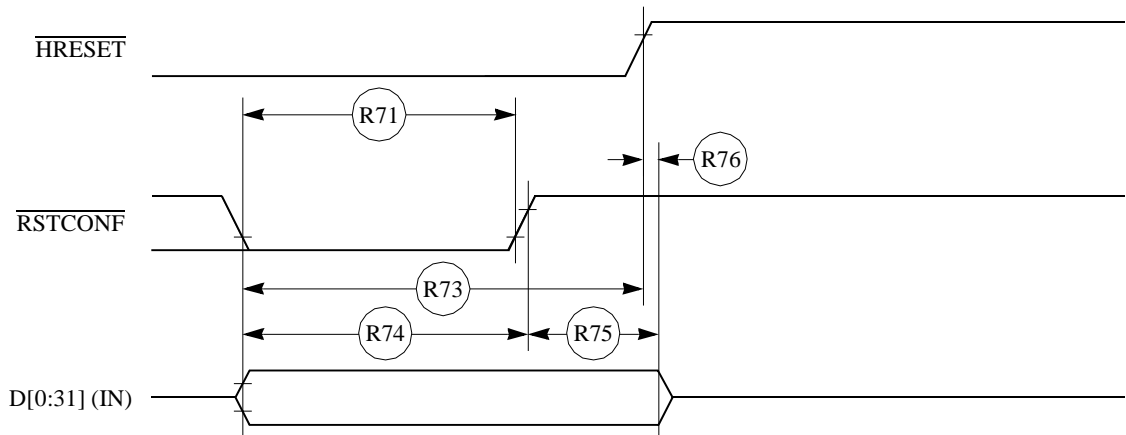


Figure 31. Reset Timing—Configuration from Data Bus

Figure 32 provides the reset timing for the data bus weak drive during configuration.

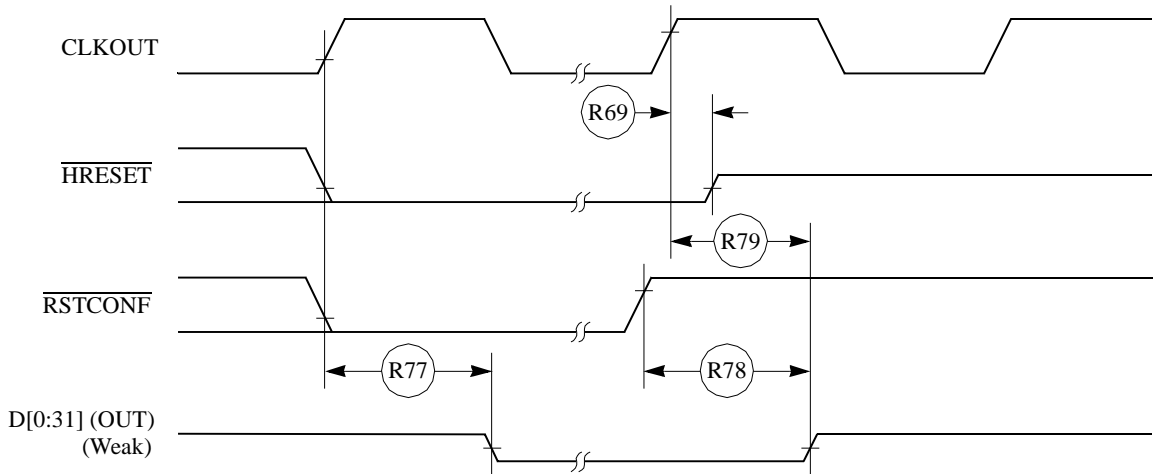


Figure 32. Reset Timing—Data Bus Weak Drive during Configuration

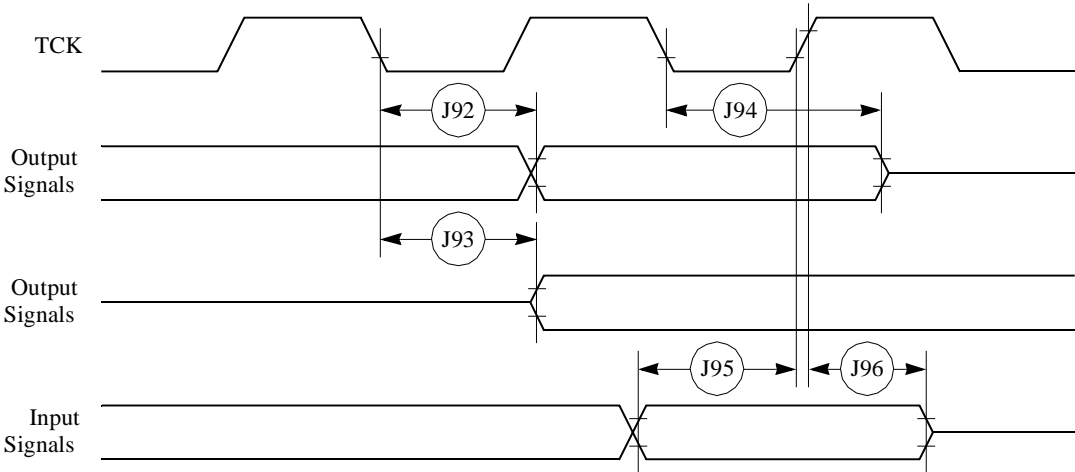


Figure 37. Boundary Scan (JTAG) Timing Diagram

8 CPM Electrical Characteristics

This section provides the AC and DC electrical specifications for the communications processor module (CPM) of the MPC850.

8.1 PIO AC Electrical Specifications

Table 13 provides the parallel I/O timings for the MPC850 as shown in Figure 38.

Table 13. Parallel I/O Timing

| Num | Characteristic | All Frequencies | | Unit |
|-----|--|-----------------|-----|------|
| | | Min | Max | |
| 29 | Data-in setup time to clock high | 15 | — | ns |
| 30 | Data-in hold time from clock high | 7.5 | — | ns |
| 31 | Clock low to data-out valid (CPU writes data, control, or direction) | — | 25 | ns |

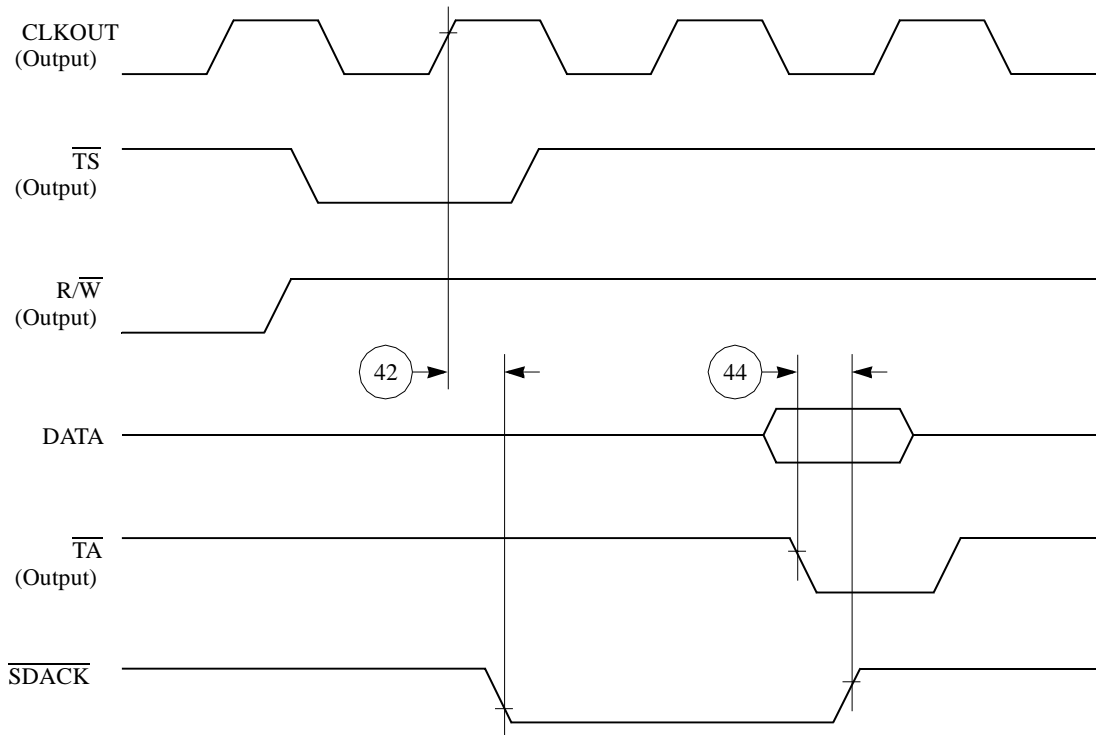


Figure 41. \overline{SDACK} Timing Diagram—Peripheral Write, \overline{TA} Sampled High at the Falling Edge of the Clock

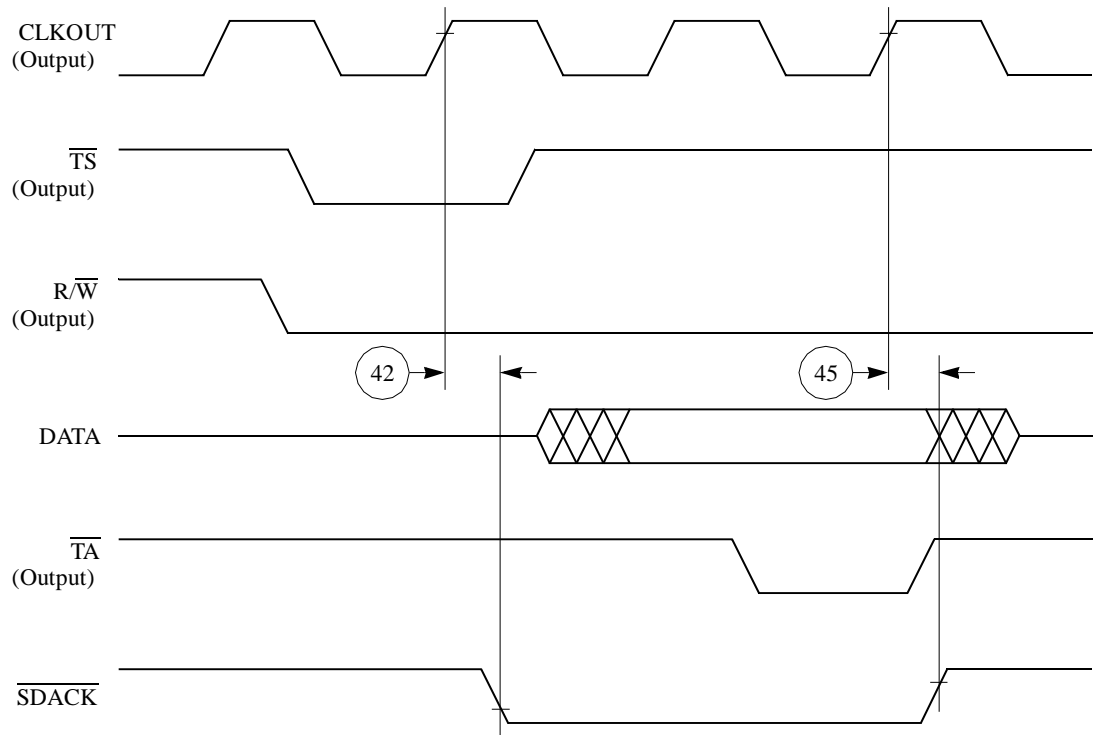


Figure 42. \overline{SDACK} Timing Diagram—Peripheral Read

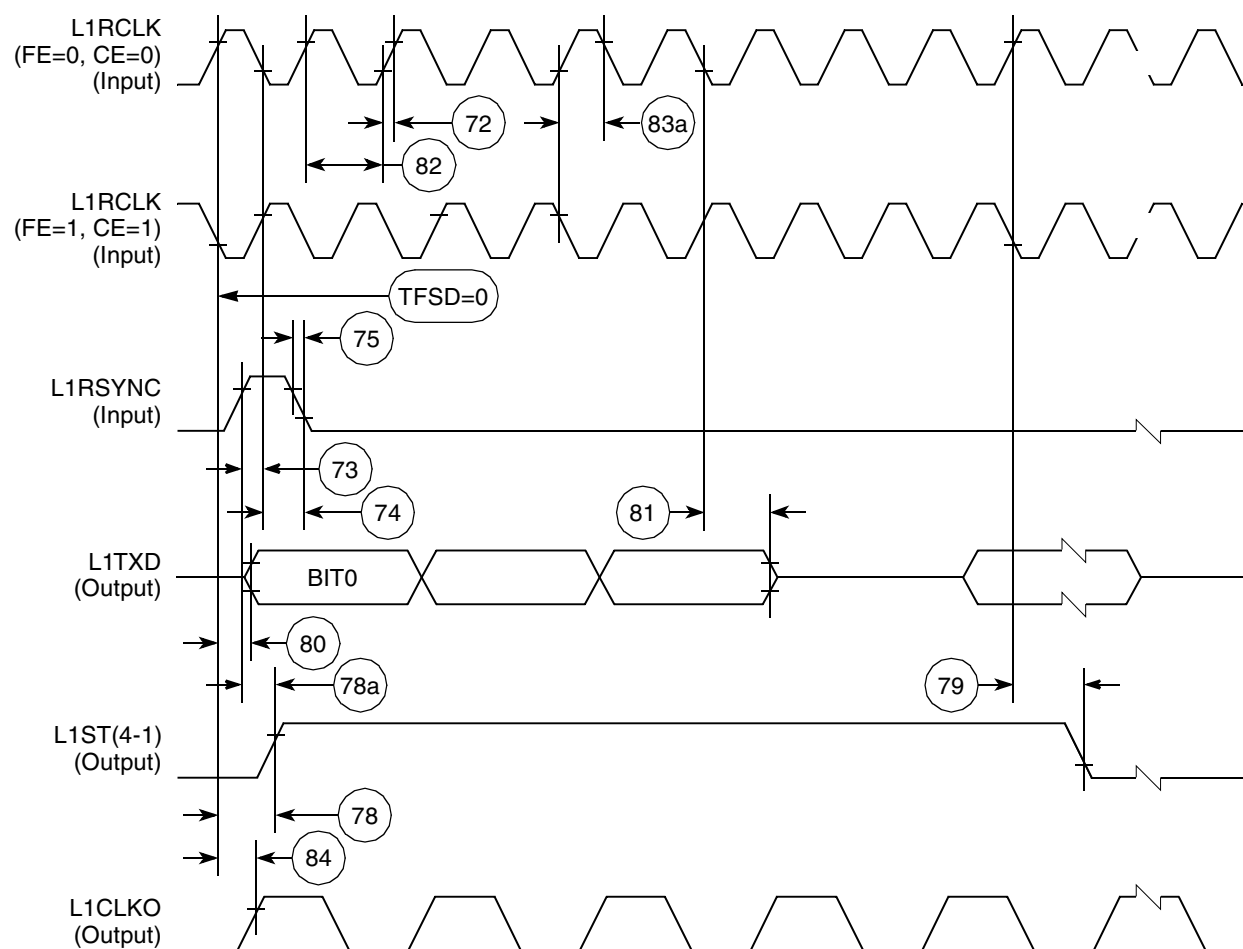


Figure 48. SI Transmit Timing with Double Speed Clocking (DSC = 1)

8.6 SCC in NMSI Mode Electrical Specifications

Table 18 provides the NMSI external clock timing.

Table 18. NMSI External Clock Timing

| Num | Characteristic | All Frequencies | | Unit |
|-----|---|-----------------|-------|------|
| | | Min | Max | |
| 100 | RCLKx and TCLKx frequency ¹ (x = 2, 3 for all specs in this table) | 1/SYNCCLK | — | ns |
| 101 | RCLKx and TCLKx width low | 1/SYNCCLK +5 | — | ns |
| 102 | RCLKx and TCLKx rise/fall time | — | 15.00 | ns |
| 103 | TXDx active delay (from TCLKx falling edge) | 0.00 | 50.00 | ns |
| 104 | $\overline{\text{RTSx}}$ active/inactive delay (from TCLKx falling edge) | 0.00 | 50.00 | ns |
| 105 | $\overline{\text{CTSx}}$ setup time to TCLKx rising edge | 5.00 | — | ns |
| 106 | RXDx setup time to RCLKx rising edge | 5.00 | — | ns |
| 107 | RXDx hold time from RCLKx rising edge ² | 5.00 | — | ns |
| 108 | $\overline{\text{CDx}}$ setup time to RCLKx rising edge | 5.00 | — | ns |

¹ The ratios SyncCLK/RCLKx and SyncCLK/TCLKx must be greater than or equal to 2.25/1.

² Also applies to $\overline{\text{CD}}$ and $\overline{\text{CTS}}$ hold time when they are used as an external sync signal.

Table 19 provides the NMSI internal clock timing.

Table 19. NMSI Internal Clock Timing

| Num | Characteristic | All Frequencies | | Unit |
|-----|---|-----------------|-----------|------|
| | | Min | Max | |
| 100 | RCLKx and TCLKx frequency ¹ (x = 2, 3 for all specs in this table) | 0.00 | SYNCCLK/3 | MHz |
| 102 | RCLKx and TCLKx rise/fall time | — | — | ns |
| 103 | TXDx active delay (from TCLKx falling edge) | 0.00 | 30.00 | ns |
| 104 | $\overline{\text{RTSx}}$ active/inactive delay (from TCLKx falling edge) | 0.00 | 30.00 | ns |
| 105 | $\overline{\text{CTSx}}$ setup time to TCLKx rising edge | 40.00 | — | ns |
| 106 | RXDx setup time to RCLKx rising edge | 40.00 | — | ns |
| 107 | RXDx hold time from RCLKx rising edge ² | 0.00 | — | ns |
| 108 | $\overline{\text{CDx}}$ setup time to RCLKx rising edge | 40.00 | — | ns |

¹ The ratios SyncCLK/RCLKx and SyncCLK/TCLK1x must be greater or equal to 3/1.

² Also applies to $\overline{\text{CD}}$ and $\overline{\text{CTS}}$ hold time when they are used as an external sync signals.

Table 20. Ethernet Timing (continued)

| Num | Characteristic | All Frequencies | | Unit |
|-----|---|-----------------|-------|------|
| | | Min | Max | |
| 134 | TENA inactive delay (from TCLKx rising edge) | 10.00 | 50.00 | ns |
| 138 | CLKOUT low to $\overline{\text{SDACK}}$ asserted ² | — | 20.00 | ns |
| 139 | CLKOUT low to $\overline{\text{SDACK}}$ negated ² | — | 20.00 | ns |

¹ The ratios SyncCLK/RCLKx and SyncCLK/TCLKx must be greater or equal to 2/1.

² $\overline{\text{SDACK}}$ is asserted whenever the SDMA writes the incoming frame destination address into memory.

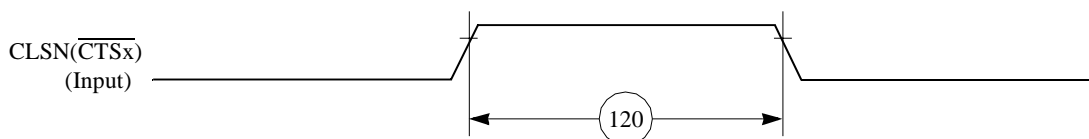


Figure 53. Ethernet Collision Timing Diagram

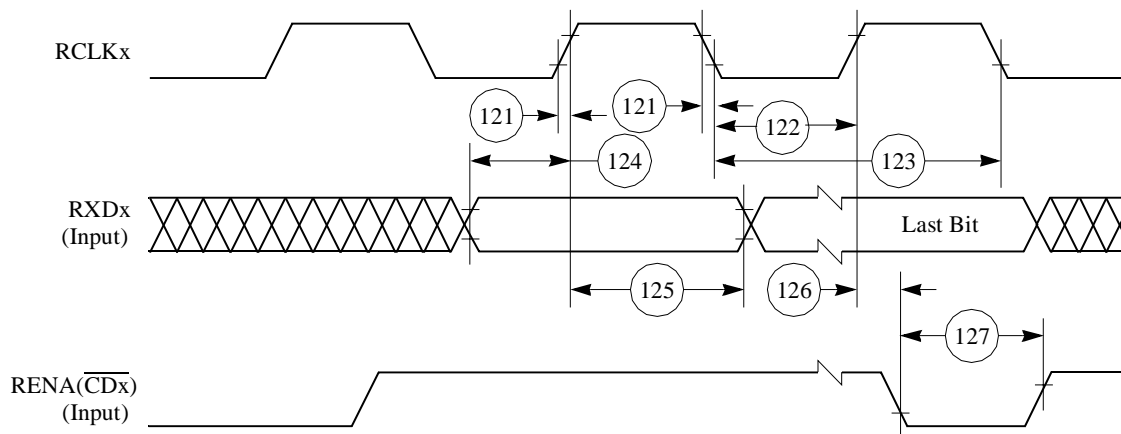


Figure 54. Ethernet Receive Timing Diagram

customers that are currently using the non-JEDEC pin numbering scheme, two sets of pinouts, JEDEC and non-JEDEC, are presented in this document.

Figure 62 shows the non-JEDEC pinout of the PBGA package as viewed from the top surface.

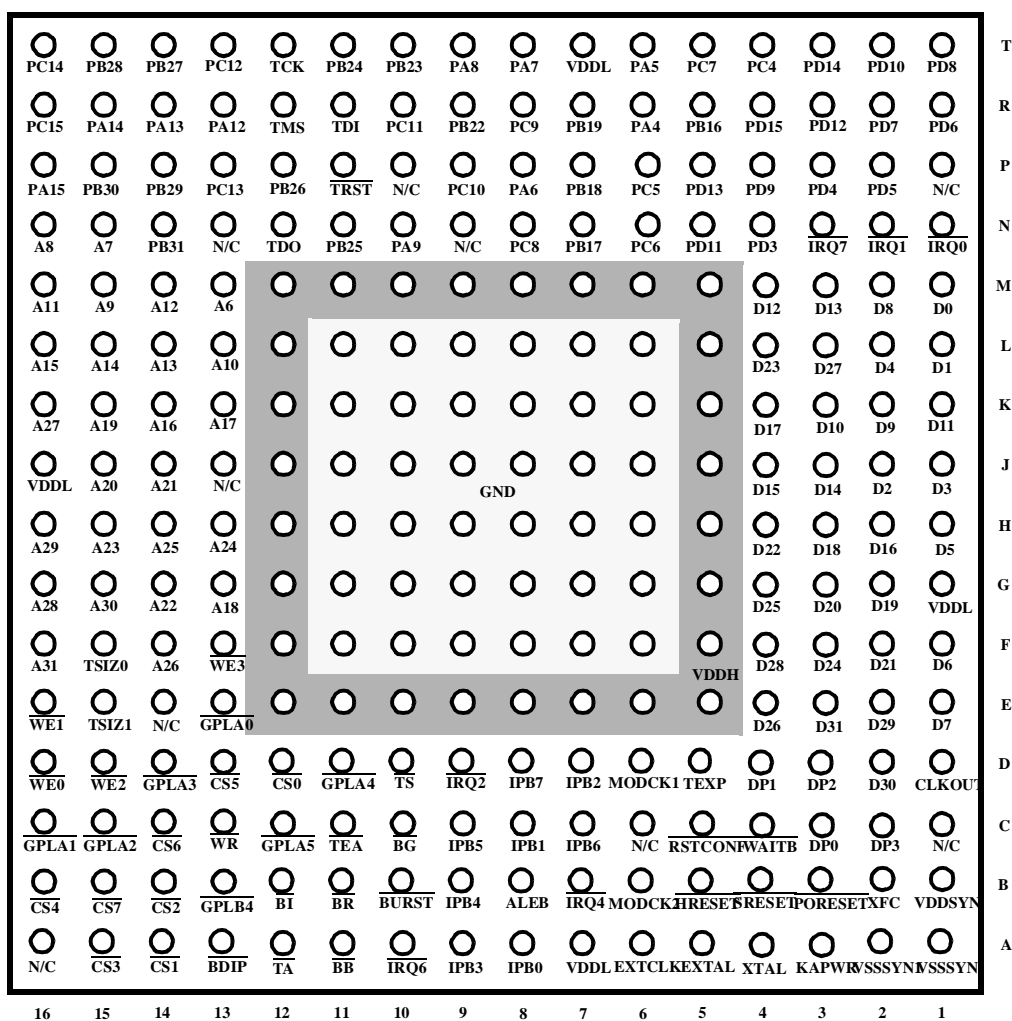
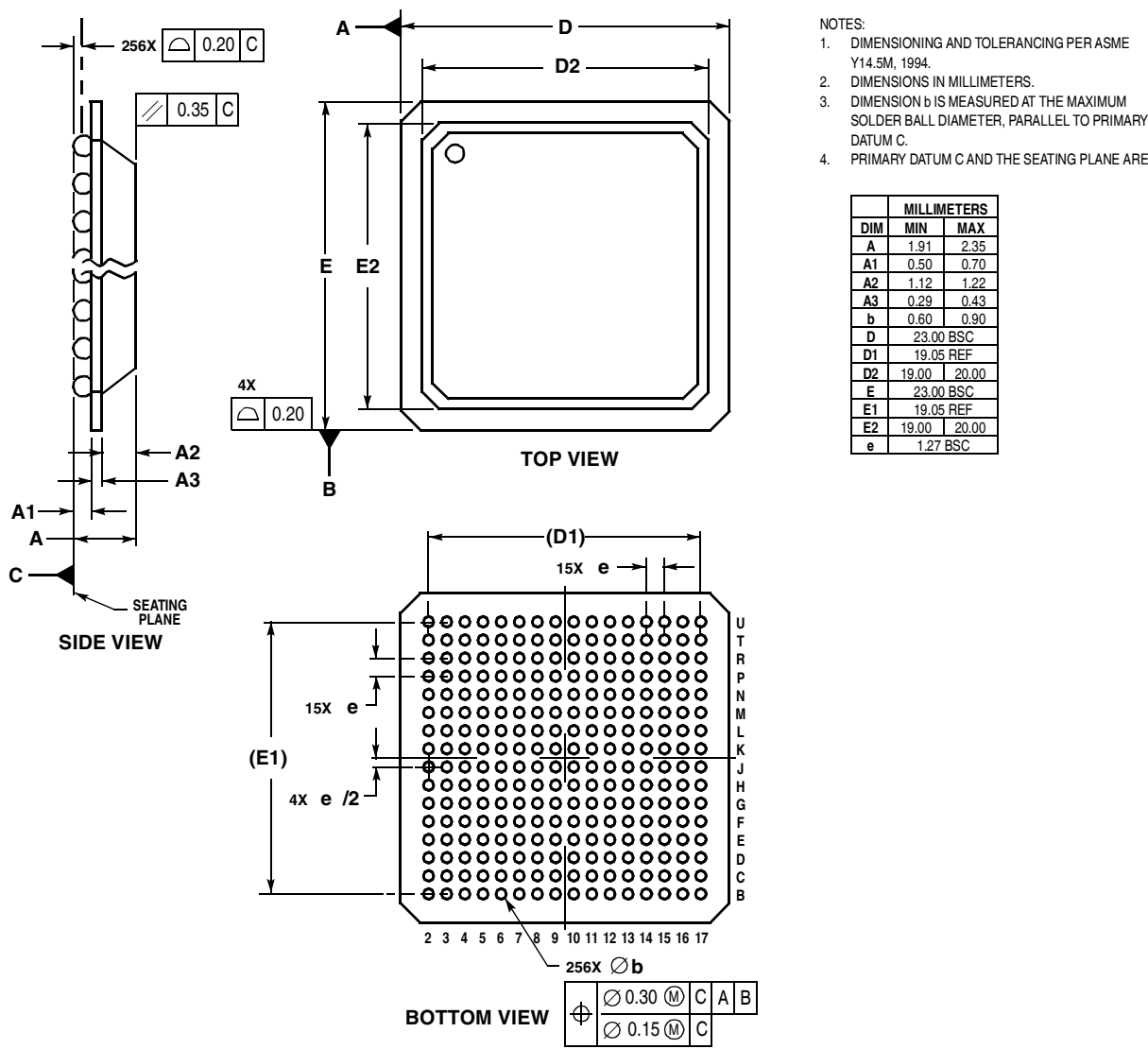


Figure 62. Pin Assignments for the PBGA (Top View)—non-JEDEC Standard

Figure 65 shows the JEDEC package dimensions of the PBGA.



CASE 1130-01
ISSUE B

Figure 65. Package Dimensions for the Plastic Ball Grid Array (PBGA)—JEDEC Standard



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